



STF24NM60N, STI24NM60N STP24NM60N, STW24NM60N

N-channel 600 V, 0.168 Ω , 17 A MDmesh™ II Power MOSFET
TO-220FP, I²PAK, TO-220 and TO-247

Features

Order codes	V_{DSS} (@T _{jmax})	$R_{DS(on)}$ max.	I_D
STF24NM60N	650 V	< 0.19 Ω	17 A
STI24NM60N	650 V	< 0.19 Ω	17 A
STP24NM60N	650 V	< 0.19 Ω	17 A
STW24NM60N	650 V	< 0.19 Ω	17 A

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

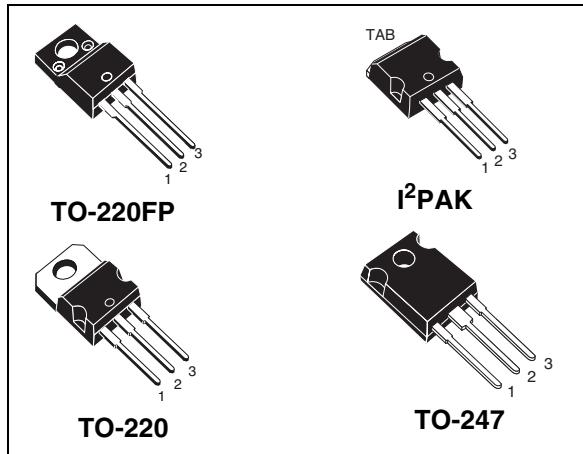
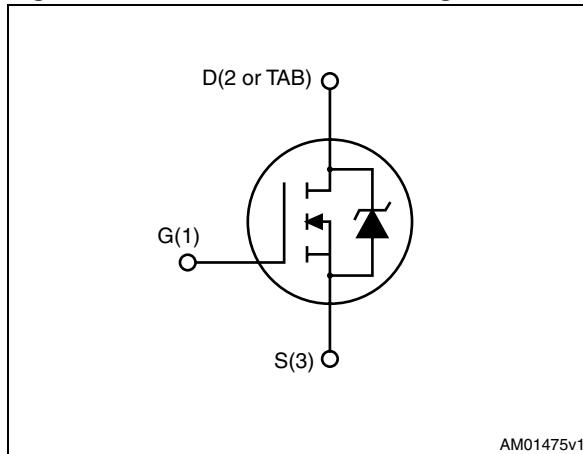


Figure 1. Internal schematic diagram



AM01475v1

Table 1. Device summary

Order codes	Marking	Package	Packaging
STF24NM60N	24NM60N	TO-220FP	Tube
STI24NM60N		I ² PAK	
STP24NM60N		TO-220	
STW24NM60N		TO-247	

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value		Unit
		I ² PAK TO-220 TO-247	TO-220FP	
V _{GS}	Gate- source voltage	± 30		V
I _D	Drain current (continuous) at T _C = 25 °C	17	17 ⁽¹⁾	A
I _D	Drain current (continuous) at T _C = 100 °C	11	11 ⁽¹⁾	A
I _{DM} ⁽²⁾	Drain current (pulsed)	68	68 ⁽¹⁾	A
P _{TOT}	Total dissipation at T _C = 25 °C	125	30	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	15		V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s;T _C =25 °C)	2500		V
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150		°C

1. Limited only by maximum temperature allowed.
2. Pulse width limited by safe operating area.
3. I_{SD} ≤ 17 A, di/dt ≤ 400 A/μs, peak V_{DS} ≤ V_{(BR)DSS}, V_{DD} = 80% V_{(BR)DSS}

Table 3. Thermal data

Symbol	Parameter	Value				Unit	
		TO-220FP	I ² PAK	TO-220	TO-247		
R _{thj-case}	Thermal resistance junction-case max.	4	1		°C/W		
R _{thj-amb}	Thermal resistance junction-ambient max.	62.5		50	°C/W		
T _J	Maximum lead temperature for soldering purpose	300				°C	

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or non-repetitive (pulse width limited by T _J max)	6	A
E _{AS}	Single pulse avalanche energy (starting T _J = 25 °C, I _D = I _{AR} , V _{DD} = 50 V)	300	mJ

2 Electrical characteristics

($T_{case} = 25^\circ\text{C}$ unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage ($V_{GS} = 0$)	$I_D = 1 \text{ mA}$	600			V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = 600 \text{ V}$ $V_{DS} = 600 \text{ V}, T_C = 125^\circ\text{C}$			1 100	μA μA
I_{GSS}	Gate-body leakage current ($V_{DS} = 0$)	$V_{GS} = \pm 25 \text{ V}$			100	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2	3	4	V
$R_{DS(\text{on})}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$		0.168	0.19	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance					pF
C_{oss}	Output capacitance					pF
C_{rss}	Reverse transfer capacitance	$V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0$	-	1400 44 7.4	-	pF
$C_{oss \text{ eq.}}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0 \text{ to } 480 \text{ V}, V_{GS} = 0$	-	190	-	pF
R_g	Gate input resistance	f=1 MHz open drain	-	5	-	Ω
Q_g	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 17 \text{ A}, V_{GS} = 10 \text{ V}$	-	46	-	nC
Q_{gs}	Gate-source charge			7	-	nC
Q_{gd}	Gate-drain charge	(see Figure 19)		23		nC

1. $C_{o(\text{eff})}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS} .

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 300 \text{ V}$, $I_D = 8.5 \text{ A}$, $R_G = 4.7 \Omega$, $V_{GS} = 10 \text{ V}$ (see Figure 18)	-	11.5	ns	
$t_{r(v)}$	Voltage rise time			16.5		
$t_{d(off)}$	Turn-off-delay time			73	ns	
$t_{f(i)}$	Fall time			37		

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
I_{SD}	Source-drain current		-	17	A	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)			68		
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 17 \text{ A}$, $V_{GS} = 0$	-	1.6	V	
t_{rr}	Reverse recovery time	$I_{SD} = 17 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 60 \text{ V}$ (see Figure 20)	-	340	ns	μC
Q_{rr}	Reverse recovery charge			4.6		
I_{RRM}	Reverse recovery current			27		
t_{rr}	Reverse recovery time	$I_{SD} = 17 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 60 \text{ V}$, $T_J = 150^\circ\text{C}$ (see Figure 20)	-	404	ns	μC
Q_{rr}	Reverse recovery charge			5.7		
I_{RRM}	Reverse recovery current			28		

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220FP

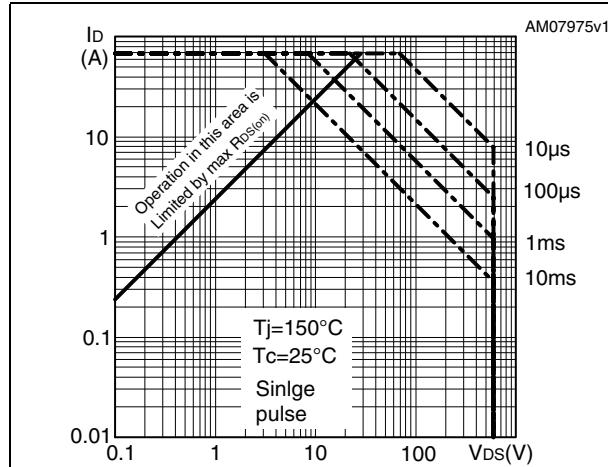


Figure 3. Thermal impedance for TO-220FP

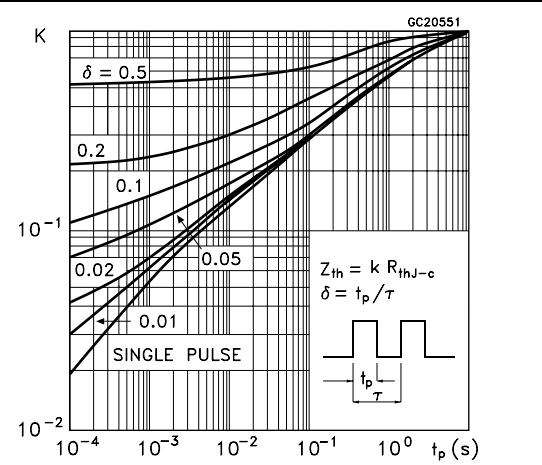
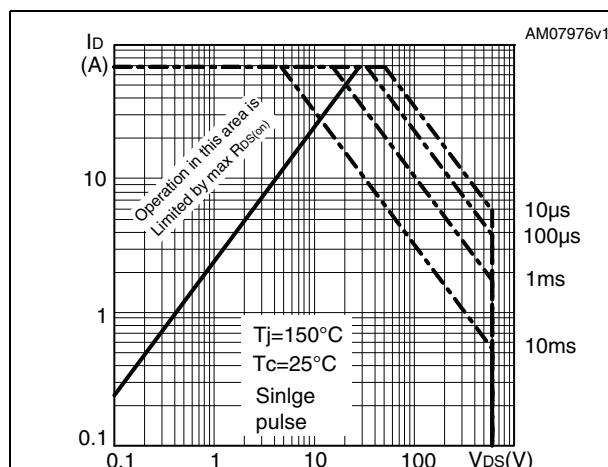
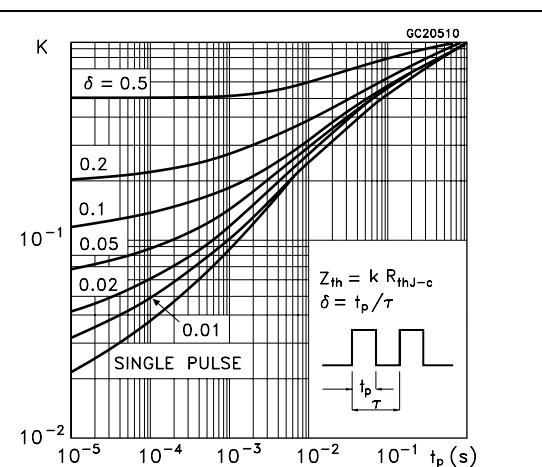
Figure 4. Safe operating area for I²PAK and TO-220Figure 5. Thermal impedance for I²PAK and TO-220

Figure 6. Safe operating area for TO-247

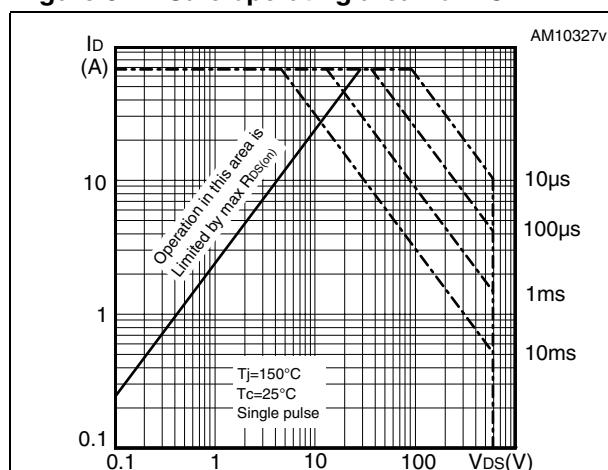


Figure 7. Thermal impedance for TO-247

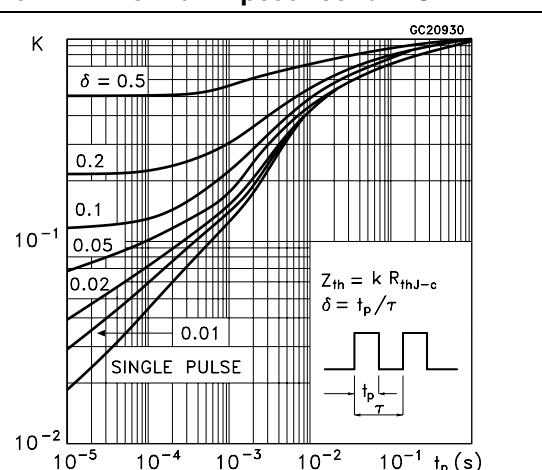


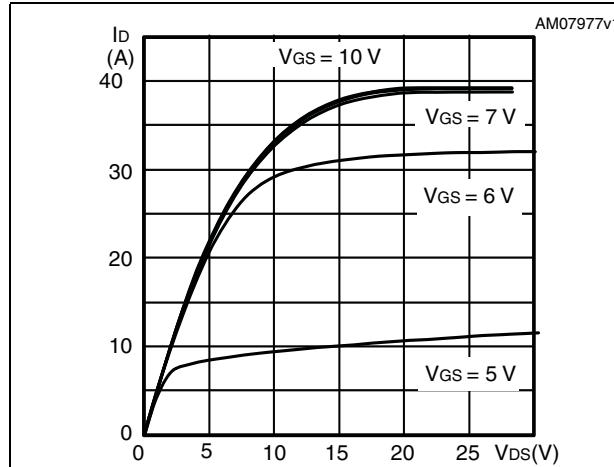
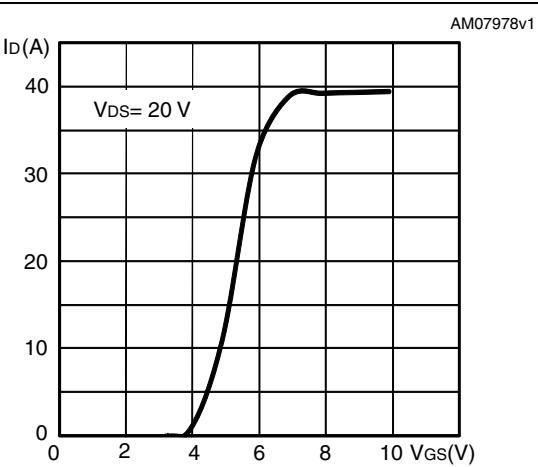
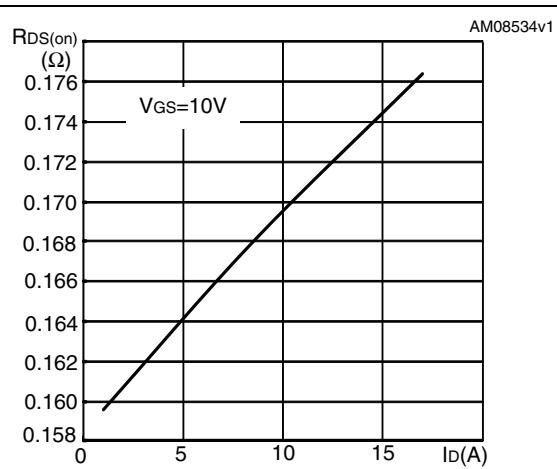
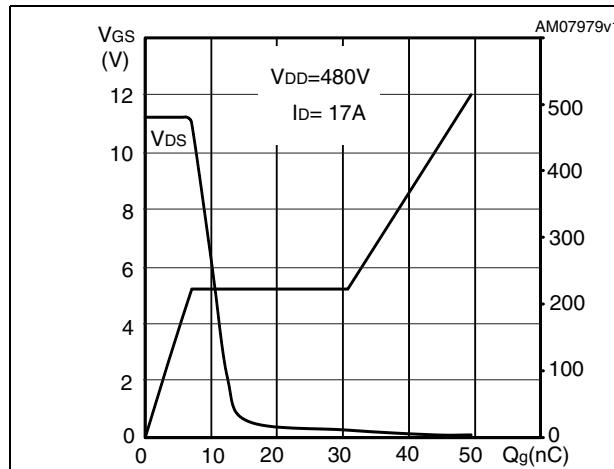
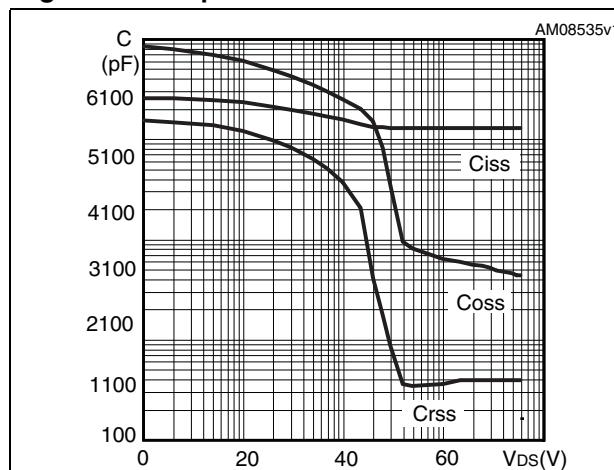
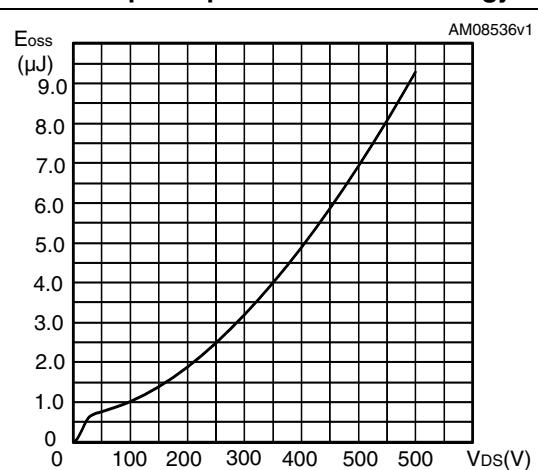
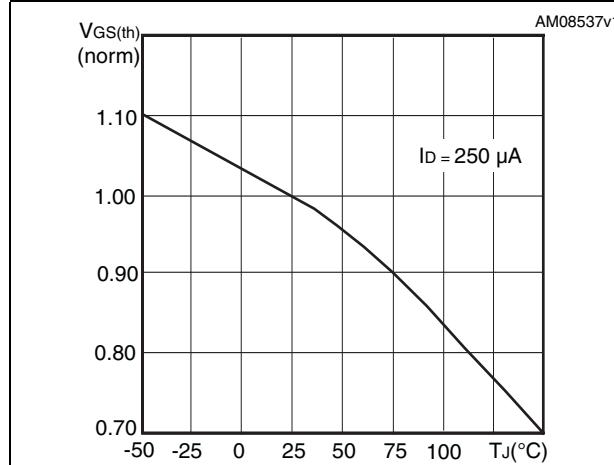
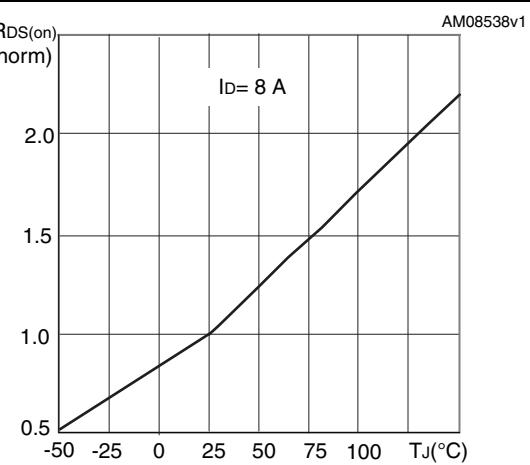
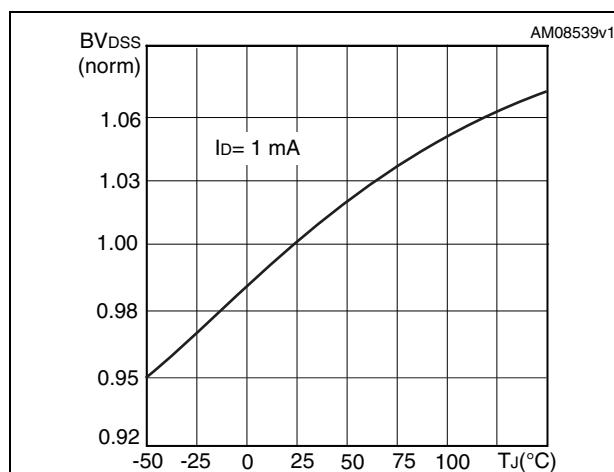
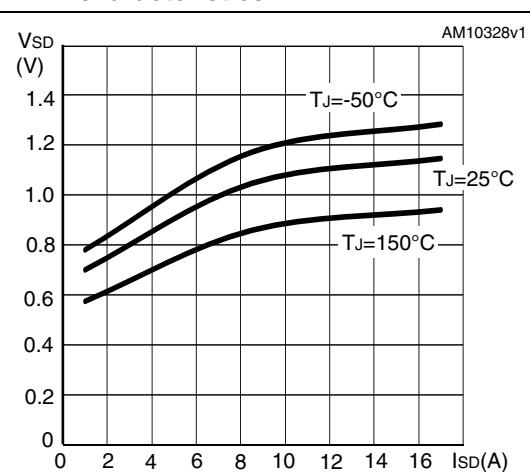
Figure 8. Output characteristics**Figure 9. Transfer characteristics****Figure 10. Gate charge vs gate-source voltage** **Figure 11. Static drain-source on resistance****Figure 12. Capacitance variations****Figure 13. Output capacitance stored energy**

Figure 14. Normalized gate threshold voltage vs temperature**Figure 15. Normalized on resistance vs temperature****Figure 16. Normalized $B_{V_{DSS}}$ vs temperature****Figure 17. Source-drain diode forward characteristics**

3 Test circuits

Figure 18. Switching times test circuit for resistive load

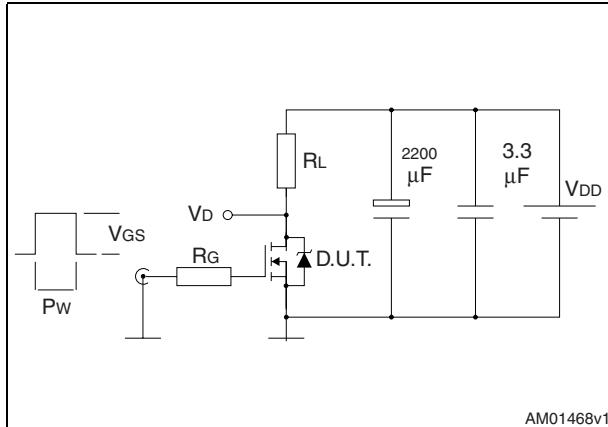


Figure 19. Gate charge test circuit

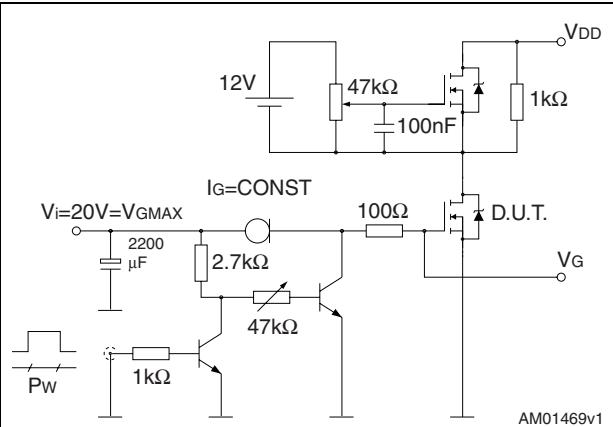


Figure 20. Test circuit for inductive load switching and diode recovery times

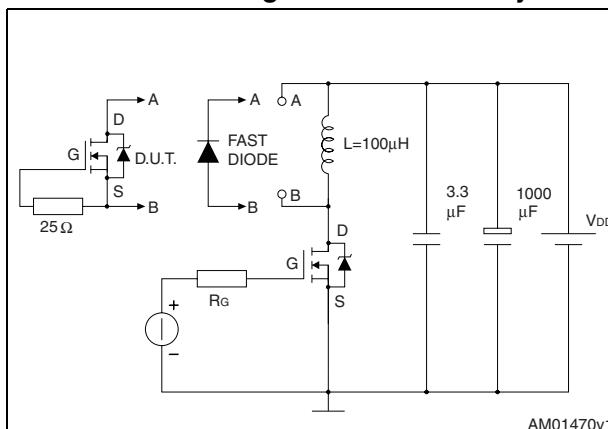


Figure 21. Unclamped inductive load test circuit

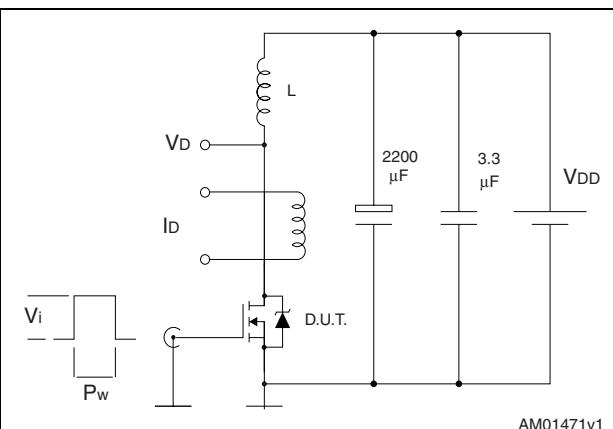


Figure 22. Unclamped inductive waveform

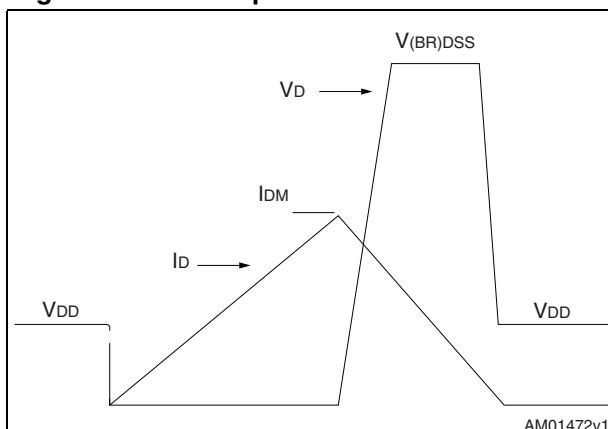
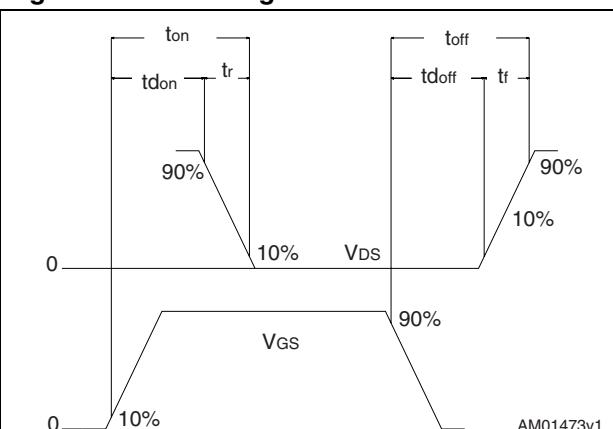


Figure 23. Switching time waveform

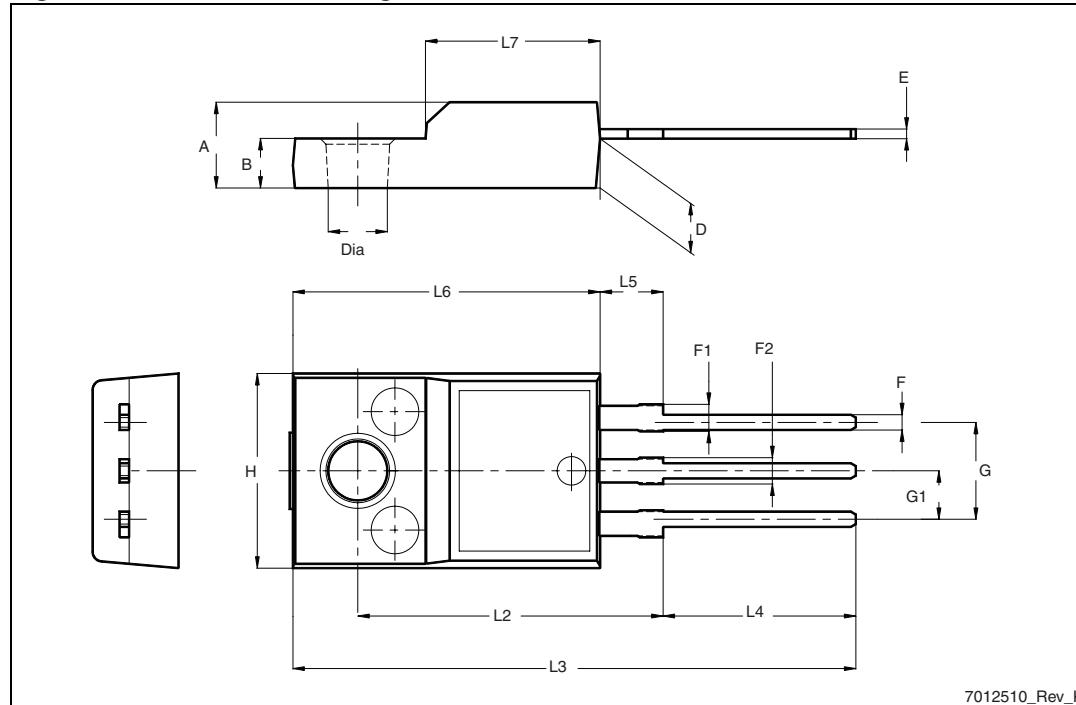


4 Package mechanical data

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Table 9. TO-220FP mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Figure 24. TO-220FP drawing

7012510_Rev_K

Table 10. I²PAK (TO-262) mechanical data

DIM.	mm.		
	min.	typ	max.
A	4.40		4.60
A1	2.40		2.72
b	0.61		0.88
b1	1.14		1.70
c	0.49		0.70
c2	1.23		1.32
D	8.95		9.35
e	2.40		2.70
e1	4.95		5.15
E	10		10.40
L	13		14
L1	3.50		3.93
L2	1.27		1.40

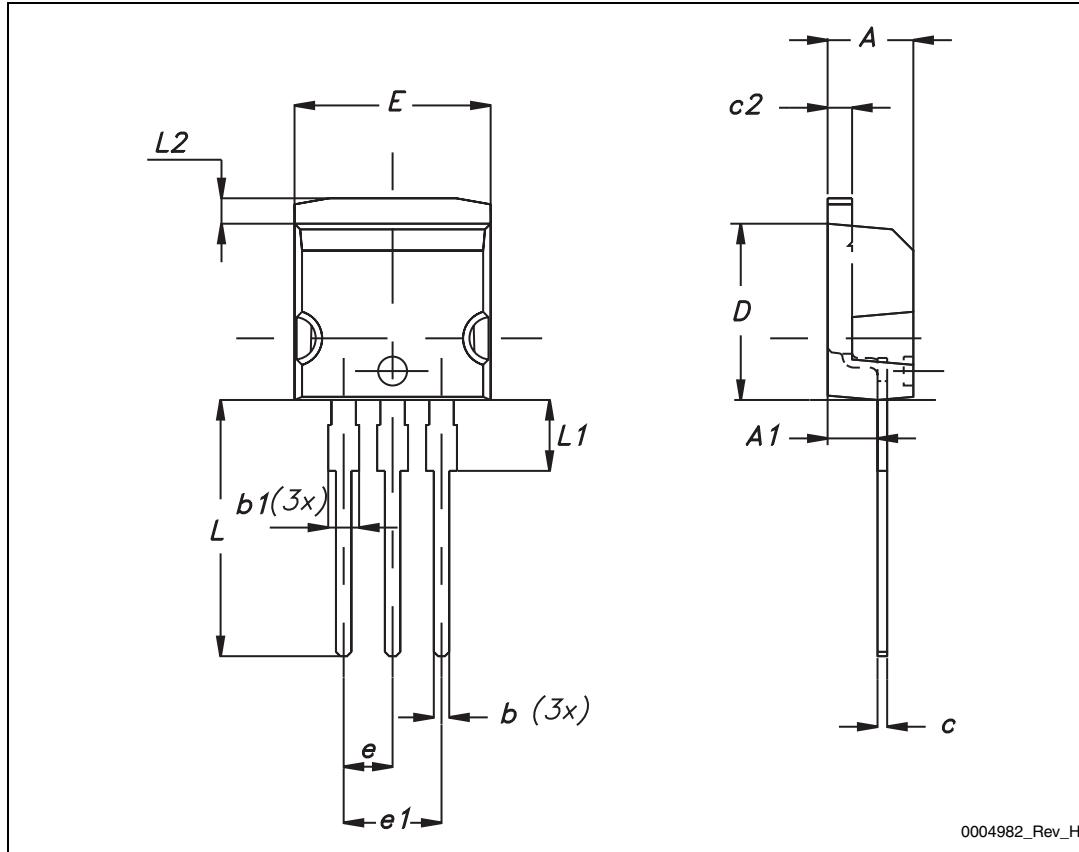
Figure 25. I²PAK (TO-262) drawing

Table 11. TO-220 type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

Figure 26. TO-220 type A drawing

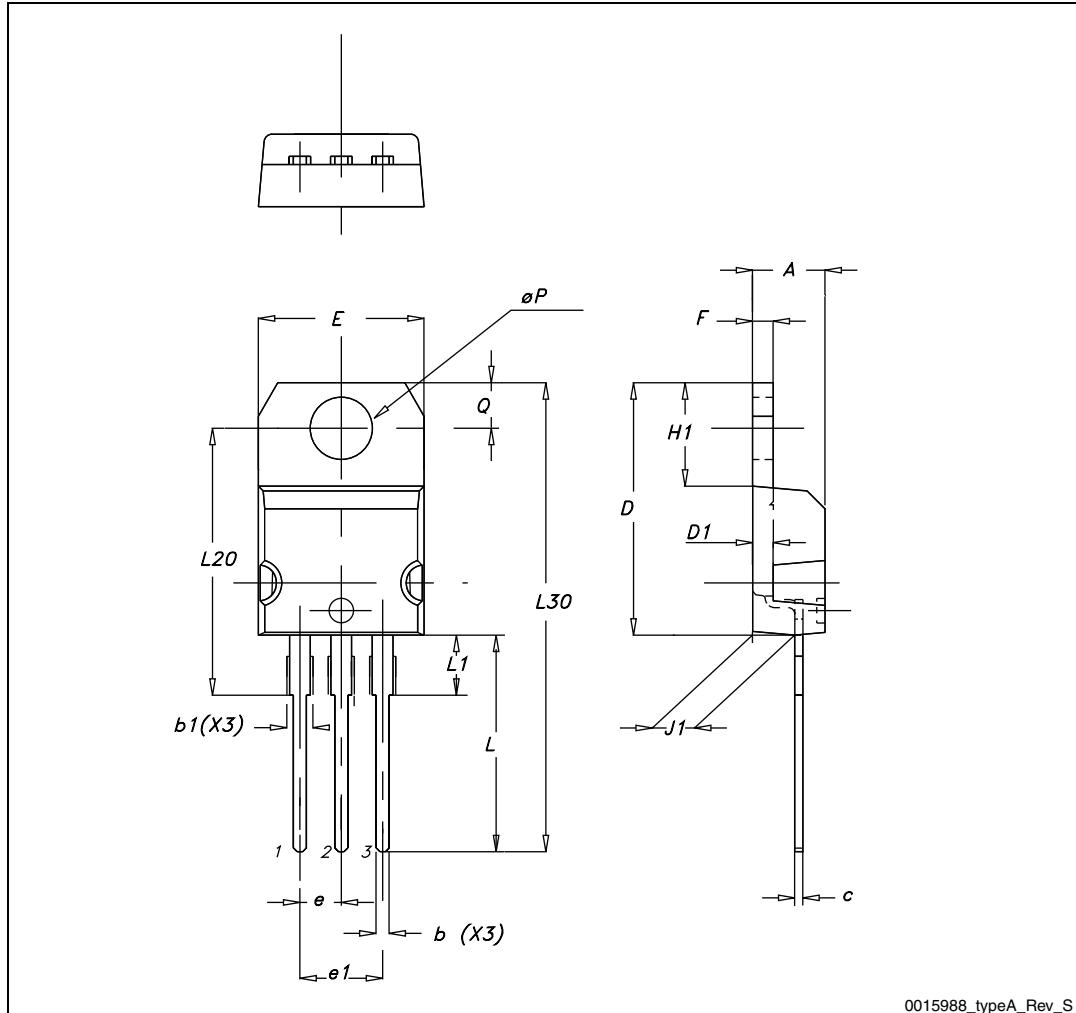
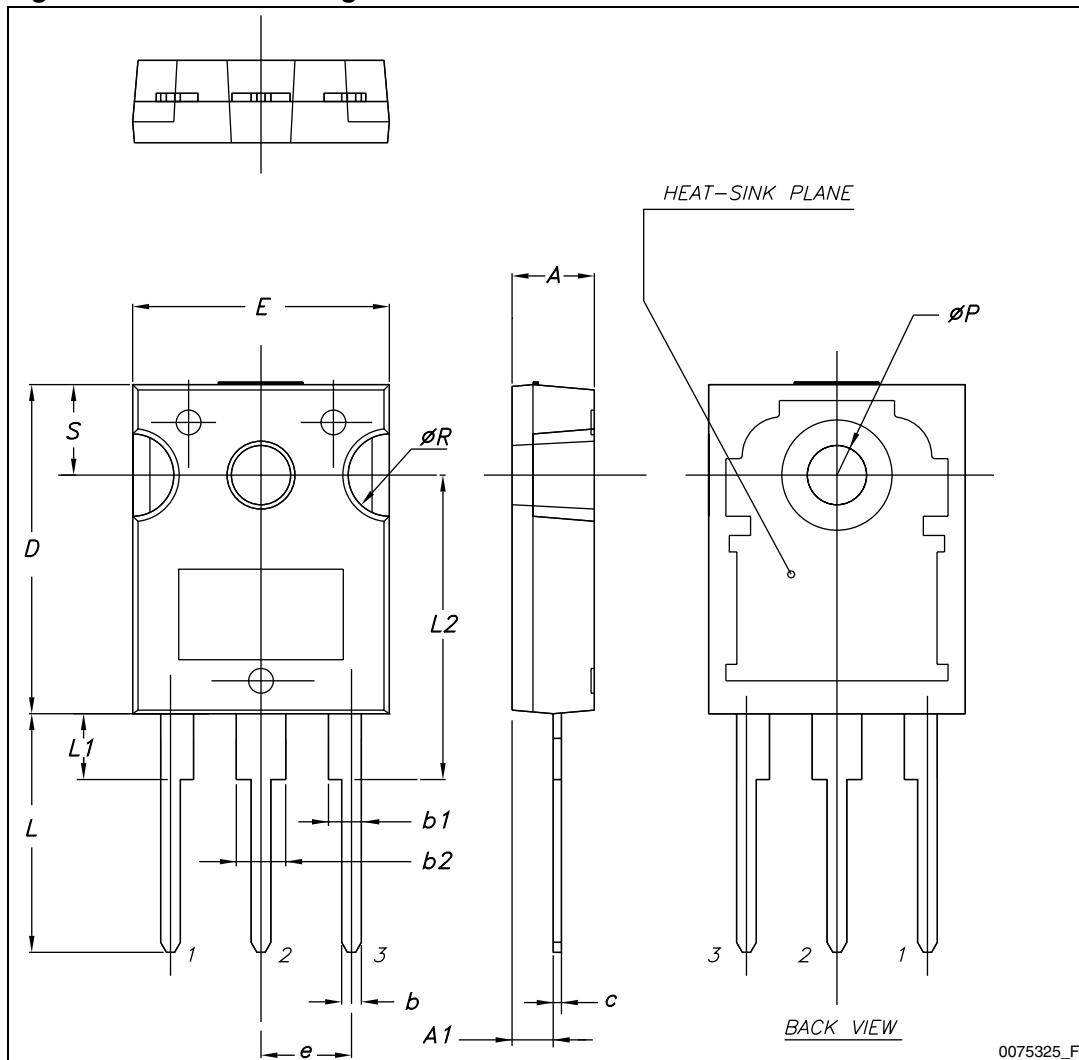


Table 12. TO-247 mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S		5.50	

Figure 27. TO-247 drawing



5 Revision history

Table 13. Document revision history

Date	Revision	Changes
05-Jan-2011	1	First release.
01-Jul-2011	2	<ul style="list-style-type: none">– Corrected $R_{thj-amb}$ value (see Table 3: Thermal data)– Added new package and mechanical data: TO-247.
22-Aug-2011	3	<p>Inserted device in I²PAK:</p> <ul style="list-style-type: none">– updated Table 1: Device summary, Table 2: Absolute maximum ratings, Table 3: Thermal data– inserted new mechanical data in Section 4: Package mechanical data

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